

RLM-0603-C Series Current Sensor Resistor (Lead / Halogen Free)

Features / Applications:

- Power rating is up to 1/10W
- Low TCR current sensor
- Resistors are ideal for all types of current sensing
- Metal foil construction; Excellent long-term stability
- Moisture sensitivity level: MSL 1
- RoHS compliant



Electrical Specifications:

Characteristics ¹	Feature	
Power Rating ²	1/10 W	
Resistance Value(mΩ)	5 \ 10 mΩ 20 mΩ	
Temperature Coefficient of Resistance(ppm/°C)	± 150 ± 100	
Operation Temperature Range	-55°C to +125°C	
Maximum Working Voltage (V)	(P*R) ^{1/2}	

Note:

- 1. For detailed information see table on page 3
- 2. For sensors operated at ambient temperature in excess of 70°C, the maximum load shall be derated in accordance with the following curve.

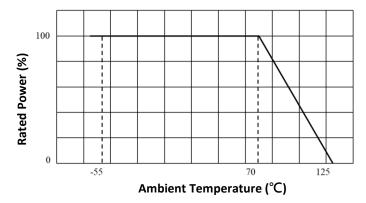


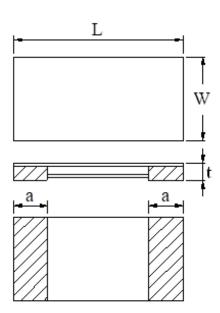
Figure 1. : Power Temperature Derating Curve

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Outline Drawing:





Resistance Range(mΩ)	L	W	а	t
5 \ 10	0.60 ± 0.05	0.31 ± 0.05	0.15 ± 0.06	0.35 MAX
20	0.60 ± 0.05	0.31 ± 0.05	0.15 ± 0.06	0.30 MAX

(Unit:mm)

Type Designation:

R L M - 0 6 0 3 - C - | NH

(1) (2) (3) (4) (5)

Note:

(1) Series No.

(2) Size

(3) Power Rating :C = 1/10W

(4) Resistance value : $0R5m = 0.5m\Omega$; $R002 = 2m\Omega$; $R010 = 10m\Omega$; $R020 = 20m\Omega$

(5) Tolerance: ±1%(F), ±2%(G)

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Available standard resistance values:

Decistance Values	Tolerance		
Resistance Values	±1.0%	±2.0%	
R005	✓	✓	
R010	✓	✓	
R020	✓	✓	

✓ = available

Further values and tolerances on request.

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Reliability Performance:

Test Item	Condition of Test	Requirements
Short Time Overload	2.5 x Rated power for 5 seconds Refer to JIS C 5201-1 4.13	ΔR: ±1.0%
Thermal Cycling	-55 to 125°C 100 cycles, 15 min at each extreme condition Refer to JIS C 5201-1 4.19	ΔR: ±2.0%
Low Temperature Storage	Kept at -55℃, 1000 hours Refer to JIS C 5201-1 4.23.4	ΔR: ± 2.0%
Resistance to Soldering Heat	Dipped into solder at $260 \pm 5^{\circ}$ C for 10 ± 1 seconds Refer to JIS C 5201-1 4.18	ΔR: ±1.0%
Load Life	Rated voltage for 1.5hours followed by a pause 0.5hour at 70 ± 3°C Cycle repeated 1000 hours Refer to JIS C 5201-1 4.25	ΔR: ±2.0%
Damp Heat with Load	60 ± 2°C with relative humidity 90% to 95%. D.C. rated voltage for 1.5 hours ON and 30 minutes OFF. Cycle repeated 1,000 hours Refer to JIS C 5201-1 4.24	ΔR: ±2.0%
High Temperature Exposure	Kept at 125℃ for 1000 hours Refer to JIS C 5201-1 4.23.2	ΔR: ± 2.0%
Solderability	Temperature of Solder : $245 \pm 5^{\circ}$ C Immersion Duration : 3 ± 0.5 second Refer to JIS C 5201-1 4.17	Uniform coating of solder cover minimum of 95% surface being immersed
Mechanical Shock	100 G's for 6milliseconds. 5 pulses $\Delta R:\pm 1.09$ Refer to JIS C 5201-1 4.21	
Substrate Bending	Glass-Epoxy board thickness: 1.6mm Bending width: 2mm Between the fulcrums: 90mm Refer to JIS C 5201-1 4.33	ΔR: ±1.0%

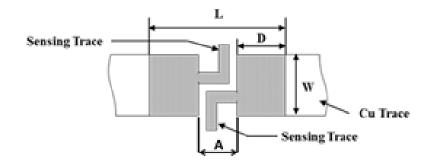
Note : Measurement at 24 \pm 4 hours after test conclusion for all reliability tests-parts.

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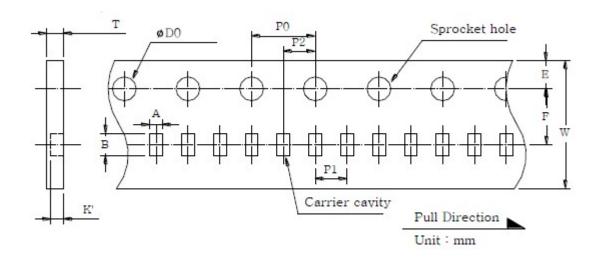
Recommend Solder Pad Dimensions:



Dimensions (mm)	W	L	D	Α
5 、 10 mΩ	0.32	0.75	0.3	0.15

Packaging:

Tape packaging dimensions:



Α	$\boldsymbol{0.38 \pm 0.02}$	F	3.50 ± 0.05	10P0	40.00 ± 0.20
В	0.68 ± 0.02	P1	$\boldsymbol{2.00 \pm 0.05}$	К'	0.28 ± 0.02
D0	$\textbf{1.55} \pm \textbf{0.03}$	P2	$\textbf{2.00} \pm \textbf{0.05}$	Т	0.42 ± 0.02
E	$\textbf{1.75} \pm \textbf{0.05}$	P0	$\textbf{4.00} \pm \textbf{0.10}$		

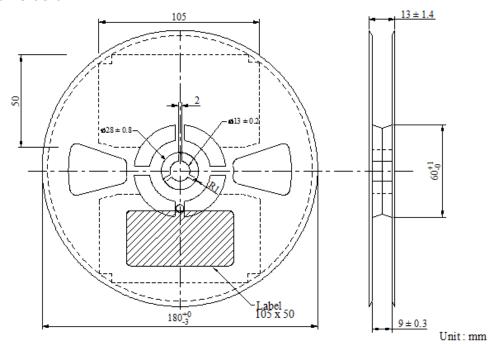
Unit: mm

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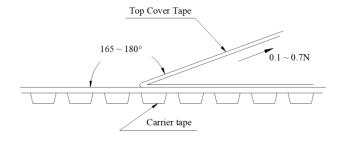
Reel dimensions:



Peel Strength of Top Cover Tape:

The peel speed shall be about 300mm/min.

The peel force of top cover tape shall between 0.1 to 0.7N



Number of Taping:

10,000 pieces / reel

Label Marking:

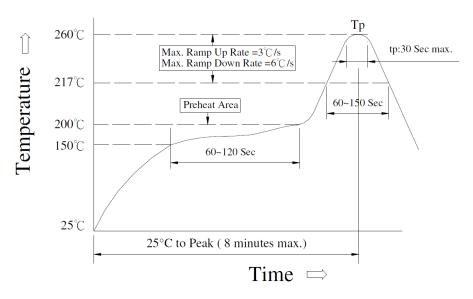
The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin

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Recommend Soldering Conditions: :



Meet JEDEC-020D

(1) Reflow Soldering Method:

Reflow Soldering	Tp:255 to 260℃ Max.30 seconds (Tp)
	217°C 60 to 150 seconds
Pre-Heat	150 to 200℃ 60 to 120 seconds
Time 25℃ to peak temperature	8 minutes max

(2) Soldering Iron Method: 350± 5°C max.3 seconds

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Care Note:

Care note for storage

- (1) Current sensor shall be stored in a environment where temperature and humidity must be controlled (temperature 5 to 40°C, humidity 30 to 80% RH). However, the humidity should be maintained as low as possible.
- (2) Current sensor shall not be stored under direct sunlight.
- (3) Current sensor shall be stored in condition without moisture, dust, any material defect solderability, or hazardous gas (i.e. Chlorination hydrogen, sulfurous acid gas, and sulfuration hydrogen)
- (4) The sensor can be stored for at least one year under the condition mentioned above.

Care note for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.

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